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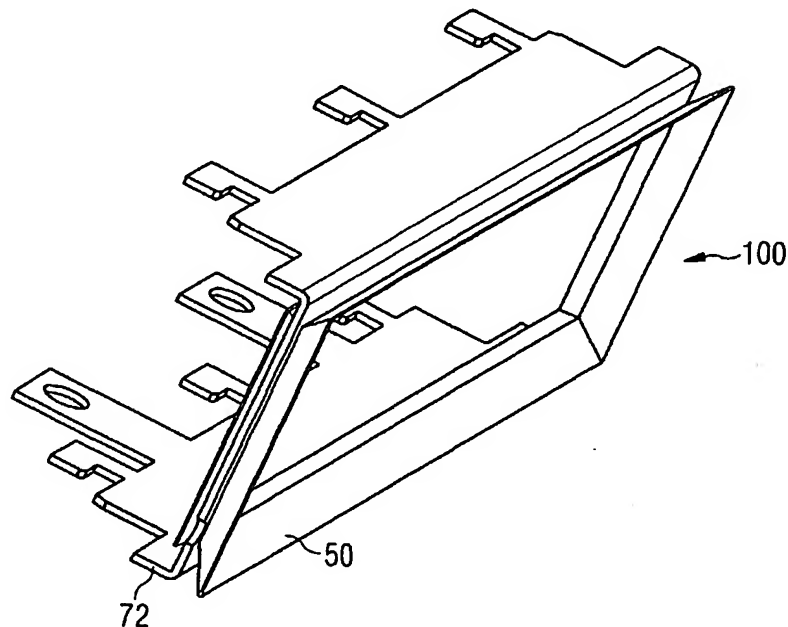
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(54) Title: COMPONENT CARRIER



(57) Abstract: The present invention relates to a component carrier which includes a frame (72) and a sealing lip (50). The frame includes walls defining an internal opening. The frame may be made of metal and the sealing lip of thermoplastic elastomer. The sealing lip is a single piece which is applied to the frame by injection molding or spraying. The frame may further include recesses or openings along the walls defining its cavity. The cooling thermoplastic elastomer may then grip or adhere to the walls so as to retain its shape. The current invention provides increased compensation tolerances for components accommodated therein.



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